IPC ASSOCIATION ELECTRONIE		Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			nder both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard  Form Ty  http://www.ipc.org/IPC-175x  Distribut				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					s Materials	ials and Mfg Information			
Supplie	r Information														
ompany	name*	Company unique ID			J	Unique ID Authority					Response Date*				
nsemi											20	2025-07-06			
Contact N	Name	Title - Contact			I	Phone - Contact*				E	Email - Contact*				
Product-	Env-Stewards		Product Enviro Compliance			1	NA				P	Product-Env-Stewards@onsemi.com			
uthorize	ed Representative*		Title - Representative			I	Phone - Representative*				E	Email - Representative*			
Product-	Env-Stewards		Product Enviro Compliance			1	NA				P	Product-Env-Stewards@onsemi.com			
	Requester Item Number	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Version	n N	Manufacturing Site		Weig	nt*	UOM	Unit Type
		NSS60601MZ4T3G NPN 60V/6A		NPN 60V/6A LOV	JOW VCE(SAT)		2025-07-06		N	MY1		108.5	3	mg	Each
Ianufa	acturing Process Infor				amp 000 1 fay										
	8		•		-STD-020 MSL	. Kating		ess Body	ss Body Temperature   Max Time at Peak		at Peak Te			of Reflow Cyc	les
	Matte Tin (Sn) - annealed		CU Alloy	1			260		С	30		seconds	3		
omments															
	naximum time at peak tempe														
or more	information regarding mate	rial composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detailed							
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledges that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 4 - Item(s	) does not contain RoHS restricted substance	es per the definition above except for selected exemp	otions Supplier Acceptance	* Accepted							
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.											
Supplier Digital Signature Ra	astislav Drska	-6_									

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.63	mg	Supplier	Silicon (Si)	7440-21-3		1.63	mg
Die Attach Solder	0.91	mg	Supplier	Silver (Ag)	7440-22-4		0.0228	mg
			A	Lead (Pb)	7439-92-1	7a	0.8418	mg
			Supplier	Tin (Sn)	7440-31-5		0.0455	mg
Lead Frame	37.17		Supplier	Silver (Ag)	7440-22-4		0.4832	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0372	mg
			Supplier	Iron (Fe)	7439-89-6		0.8921	mg
			Supplier	Copper (Cu)	7440-50-8		35.7575	mg
Mold Compound-Black	61.37			Epoxy resin	proprietary data		4.2959	mg
			Supplier	Phenolic Resin	Proprietary Data		1.8411	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		6.137	mg
			Supplier	Carbon Black (C)	1333-86-4		0.3068	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		48.7891	mg
Plating	7.44	mg	Supplier	Tin (Sn)	7440-31-5		7.44	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg